





TECHNOLOGY HIGHLIGHTS:

- A selection of housing materials to meet a variety of production process demands
- A multitude of available integrated chip options
- Embeddable in a broad spectrum of materials
- LF. HF and RAIN UHF Options

LOW, HIGH AND ULTRAHIGH-FREQUENCY TRANSPONDERS FOR ENCLOSURE INTO VIRTUALLY ANY FORM FACTOR

- Customizable choose a size, chip and a disc or rod to fit any custom enclosure
- Unsurpassed quality fully automated manufacturing and innovative DBond[™] technology ensure tag reliability
- Reliable operation built to withstand the rigors of tag processing, including plastic injection molding

Embeddable RFID transponders allow manufacturers to integrate HID Global electronic components seamlessly into tag designs optimized for any application.

Leveraging HID experience, manufacturers and integrators can combine their specialized market expertise to deliver optimized tagging solutions for custom automation applications. Manufacturers can save the time and expense of electronics design and production, and better focus resources on providing customer solutions.

With a variety of integrated chips, HID offers a range of Embeddable RFID components various operating frequencies, and form factors for incorporation into finished tagging solutions.

Choose from:

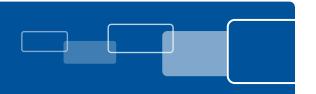
- E-Unit Disc transponders low frequency HID coils and chips, ideal for key fobs and similar simple applications.
- Inlays & Labels NFC or UHF inlays or printable labels are easy to apply via glue to smart posters etc.
- PCB Coins UHF near-field transponders, small and robust.

- Clear Disc transponders low and high frequency electronics sealed in a transparent plastic coating that provides resistance to chemical exposure, shock, vibration and thermal fluctuations, both during and after production.
- e-Module transponders high frequency coils in a robust housing, to withstand the high heat manufacturing processes of special finished tags.
- Piccolino Tag transponders for space-constrained applications, our smallest disc-shaped units deliver high frequency performance and up to a 16 kbit read-write memory.

When a rod form factor suits the target housing better than a coil – E-Unit Rod transponders provide the same high-performance coil design at the heart of the HID Glass Tag family, for embedding into your preferred housing. Rod-shaped units may also be preferred when a more precisely directed radio frequency field is needed. If a standard configuration does not fulfill your needs, HID engineers can customize a transponder unit to meet your requirements.



Embeddable RFID



SPECIFICATIONS

	Embeddable RFID										
					Clear Disc						
	Hitag S		G		25	Uni	Unique		MIFARE DESFire EV1 4K		
	20 mm		30 mm	22 mm	30 mm	20 mm	30 mm	25 mm	25 mm		
Base Model Number	623116	624116	624117	612116	612117	601116	601117	607119	7A1119		
ELECTRONIC					_						
Operating Frequency		13.50	13.56 MHz								
Chip Type		HITAG S		Q5			que	MIFARE 1K	MIFARE DESFire EV1		
Memory	256 bit 2048 bit EEPROM EEPROM		2048 bit EEPROM	256 bit EEPROM		64 bit read-only		1 KB EEPROM	4 KB EEPROM		
Anti-collision	Yes							Yes			
Reading Distance	Dependent upon reader, environment and application										
PHYSICAL											
Outer Coil Diameter	Ø 0.79 in (20 mm)		Ø 1.18 in (30 mm)	Ø 0.87 in Ø 1.18 in (22 mm) (30 mm)		Ø 0.79 in (20 mm)			Ø 0.98 in (25 mm)		
Inner Coil Diameter											
Thickness	0.02 in (0.6 mm)								0.03 in (0.75mm)		
Mounting Method	Embed, glue										
Housing Material				Polyeth	ylen + Polyester (outside)					
CHEMICAL AND MECHANICAL											
Water	Depends on finished product										
Withstands Exposure To	Depends on finished product										
Vibration	Depends on finished product										
Shock	Depends on finished product										
THERMAL											
Storage	-4° to +140° F (-20° to +60° C)										
Operating	-4° to +140° F (-20° to +60° C)										
OTHER											
Standards			·		·				·		
Box Size	5000) pcs	2000 pcs	5000 pcs	2000 pcs	5000 pcs	2000 pcs	500) pcs		
Options	Alternative sizes and chips (e.g. HDX). See separate datasheet for inlays & labels.										
			Alternative size	es and chips (e.g.	HDX). See separ	rate datasheet fo	r inlays & labels.				

APPLICATION AREAS:

- Asset tracking and logistics

 - Gas bottles Utility lines

- Automation and manufacturing
 - Tool maintenance
 - Process accountability
- Medical and health
 - Consumables
 - Instruments

SPECIFICATIONS

ļ	Embeddable RFID												
	E-Unit Disc			E-Unit Rod	e-Module		Pico	PCB Coin					
	EM4305		HITAG S		HITAG S	ICODE SLIX	ICODE SLIX Vigo™		F-Mem	Monza 4E			
	24 mm	28 mm	24 mm	28 mm	15 mm	15 mm	7.5 mm	9.5 mm	6/9.5 mm	6/9.5 mm	16 mm	19/12 mm	
Base Model Number	684620	684680	623620	623610	201045	629601	629191 (SLIX) 629191-012 (SLIX2)	629190 (SLIX) 629190-012 (SLIX2)	6B0192 (6 mm) 6A9190 (9mm)	6C9192 (6 mm) 634190 (9mm)	6C6164 (EU) 6C6163 (US)	6C6166 (EU) 6C6165 (US)	
ELECTRONIC													
Operating Frequency			134.2 kHz	Z				13.56 MHz	869 MHz (EU), 915 MHz (US)				
Chip Type	EM4	EM4305 HITAG S			HITAG S	ICODE SLIX	ICODE SLIX (2) Vigo F-Mem			F-Mem	Monza 4E		
Memory	512 bit E	EPROM	256 bit l	EEPROM	256 bit EEPROM	1024 bit EEPROM	SLIX - 896 Bit UM SLIX2 - 2560 Bit UM SLIX2 - 2560 Bit UM				496 bit EPC + 96 bit TID + 128 bit user		
Anti-collision	Yes								Yes				
Reading Distance		Dependent upon reader, environment and application								7.8 in (20 cm) 10 in (25 cm)			
PHYSICAL													
Outer Coil Diameter	Ø 0.97 in (Ø 24.3 mm)	Ø 1.09 in (Ø 27.8 mm)	Ø 0.97 in (Ø 24.3 mm)	Ø 1.09 in (Ø 27.8 mm)		Ø 0.57 in (14.5 mm)	Ø 0.30 in (Ø 7.5 mm)	Ø 0.37 in (Ø 9.5 mm)		5/0.37 in 9.5 mm)	Ø 0.63 in (Ø 16 mm)	0.75 x 0.47 in (19 x 12 mm)	
Inner Coil Diameter	Ø 0.79 in (Ø 20 mm)	Ø 0.93 in (Ø 23.5 mm)	Ø 0.79 in (Ø 20 mm)	Ø 0.93 in (Ø 23.5 mm)		Ø 0.27 in (Ø 6.8 mm)							
Thickness	0.03 in (0.85 mm)	0.09 in (2.2 mm)	0.03 in (0.85 mm)	0.09 in (2.2 mm)	Ø 0.07 x 0.59 in (Ø18x15 mm)	0.04 in (0.9 mm)	0.04 in (1 r	mm) / 0.03 in	0.04 in (0.9 mm)				
Mounting Method			'		En	nbed, glue		embed					
Housing Material	Depends on finished product Epoxy glob top								PCB				
CHEMICAL AND MECHANICAL													
Water	Depends on finished product					IP6	7, 68° F (20	IP68, 68° F (20° C), 3.3 ft (1 m) x 24 h					
Withstands Exposure To	Depends on finished product									Mineral oil, petroleum, salt mist, vegetable oil, Impact IEC 62262- IK08, 100 drops 5.9 ft (1.8 m), Axial/radial force 1000N			
Vibration	Depends on finished product					IEC 68.2.6 [10 g, 10 to 2000 Hz, 3 axis, 2.5 h]							
Shock	Depends on finished product						IEC 68.2.29 [40 g, 18 ms, 6 axis, 2000 times]						
THERMAL													
Storage	-40° to +140° F (-40° to +60° C)				-40° to +248° F (-40° to 120° C)		-40° to +185	-40 °to +185° F (-40° to 85° C)					
Operating	-13° to +140° F (-25° to +60° C)				-13 °to +185° F (-25° to +85° C)	-40° to +185° F (-40° to 85° C)			-40 °to +185° F (-40° to 85° C) Peak: Up to 428°F (220°C) 1x30s				
OTHER													
Standards	ISO 11784, ISO 11785			T	ISO 15693, ISO 18000-3 ISO 1569					UHF EPC Class 1 Gen 2, ISO 18000-6C			
Box Size	1250 pcs	1000 pcs	1250 pcs	1000 pcs	39 912 pcs	2000 pcs 2000 pcs 2000 pcs					2500 pcs		
Options	Alternative sizes and chips (e.g. HDX). See separate datasheet for inlays & labels.								Encoding				
Warranty		2 Years											



North America: +1 512 776 9000 • Toll Free: 1 800 237 7769 Europe, Middle East, Africa: +44 1440 714 850 Asia Pacific: +852 3160 9800 • Latin America: +52 55 5081 1650

© 2018 HID Global. All rights reserved. HID, the HID logo are trademarks or registered trademarks of HID Global in the U.S. and/or other countries. All other trademarks, service marks, and product or service names are trademarks or registered trademarks of their respective owners.

ASSA ABLOY An ASSA ABLOY Group brand

